Preferred Device

# **Complementary Silicon Plastic Power Transistors**

These devices are designed for use as high-frequency drivers in audio amplifiers.

#### **Features**

• DC Current Gain Specified to 4.0 Amperes

 $h_{FE} = 40$  (Min) @  $I_C = 3.0$  Adc = 20 (Min) @  $I_C = 4.0$  Adc

• Collector-Emitter Sustaining Voltage -

V<sub>CEO(sus)</sub> = 120 Vdc (Min); MJE15028, MJE15029 = 150 Vdc (Min); MJE15030, MJE15031

• High Current Gain - Bandwidth Product

 $f_T = 30 \text{ MHz (Min)} @ I_C = 500 \text{ mAdc}$ 

- TO-220AB Compact Package
- Pb-Free Packages are Available\*

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage MJE15028, MJE15029 MJE15030, MJE15031	V <sub>CEO</sub>	120 150	Vdc
Collector-Base Voltage MJE15028, MJE15029 MJE15030, MJE15031	V <sub>CB</sub>	120 150	Vdc
Emitter-Base Voltage	V <sub>EB</sub>	5.0	Vdc
Collector Current – Continuous – Peak	I <sub>C</sub>	8.0 16	Adc
Base Current	$I_{B}$	2.0	Adc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	50 0.40	W W/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.0 0.016	W W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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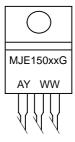
http://onsemi.com

# 8 AMPERE POWER TRANSISTORS COMPLEMENTARY SILICON 120-150 VOLTS, 50 WATTS



TO-220AB CASE 221A-09 STYLE 1

# MARKING DIAGRAM



MJE150xx = Device Code

x = 28, 29, 30, or 31 = Pb–Free Package = Assembly Location

Y = Year WW = Work Week

G

### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (Note 1) (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 0)	MJE15028, MJE15029 MJE15030, MJE15031	V <sub>CEO(sus)</sub>	120 150	- -	Vdc
Collector Cutoff Current $(V_{CE} = 120 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 150 \text{ Vdc}, I_B = 0)$	MJE15028, MJE15029 MJE15030, MJE15031	I <sub>CEO</sub>	- -	0.1 0.1	mAdc
Collector Cutoff Current $(V_{CB} = 120 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 150 \text{ Vdc}, I_E = 0)$	MJE15028, MJE15029 MJE15030, MJE15031	I <sub>CBO</sub>	1 1	10 10	μAdc
Emitter Cutoff Current (V <sub>BE</sub> = 5.0 Vdc, I <sub>C</sub> = 0)		I <sub>EBO</sub>	-	10	μAdc
ON CHARACTERISTICS (Note 1)					•
DC Current Gain		h <sub>FE</sub>	40 40 40 20	- - - -	-
DC Current Gain Linearity (V <sub>CE</sub> From 2.0 V to 20 V, I <sub>C</sub> From 0.1 A to 3 A) (NPN to PNP)	2.3	he		<b>yp</b> 2 3	
Collector–Emitter Saturation Voltage (I <sub>C</sub> = 1.0 Adc, I <sub>B</sub> = 0.1 Adc)	36.00	V <sub>CE(sat)</sub>	_	0.5	Vdc
Base–Emitter On Voltage (I <sub>C</sub> = 1.0 Adc, V <sub>CE</sub> = 2.0 Vdc)	in ice	V <sub>BE(on)</sub>	-	1.0	Vdc
DYNAMIC CHARACTERISTICS	),				
Current Gain – Bandwidth Product (Note 2) (I <sub>C</sub> = 500 mAdc, V <sub>CE</sub> = 10 Vdc, f <sub>test</sub> = 10 MHz)		fΤ	30	-	MHz

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%. 2.  $f_T = |h_{fe}| \bullet f_{test}$ .

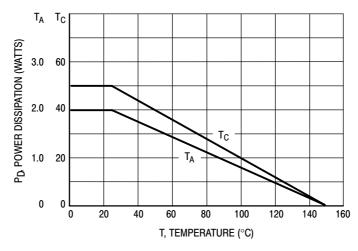


Figure 1. Power Derating

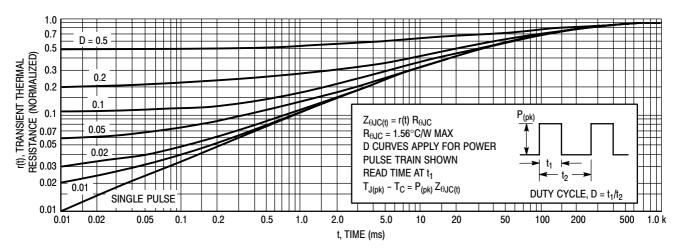


Figure 2. Thermal Response

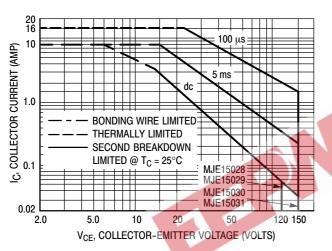


Figure 3. Forward Bias Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation then the curves indicate.

The data of Figures 3 and 4 is based on  $T_{J(pk)} = 150^{\circ} C$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} < 150^{\circ} C$ .  $T_{J(pk)}$  may be calculated from the data in Figure 2. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

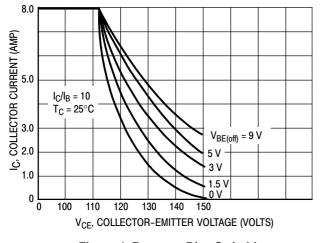


Figure 4. Reverse–Bias Switching Safe Operating Area

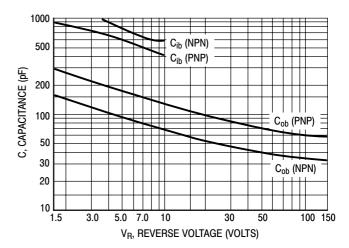
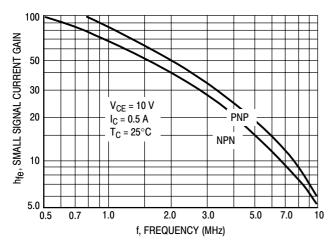


Figure 5. Capacitances



100 90 (PNP) (NPN) 10 0.1 0.2 0.5 1.0 2.0 5.0 10 I<sub>C</sub>, COLLECTOR CURRENT (AMP)

Figure 6. Small-Signal Current Gain

Figure 7. Current Gain-Bandwidth Product

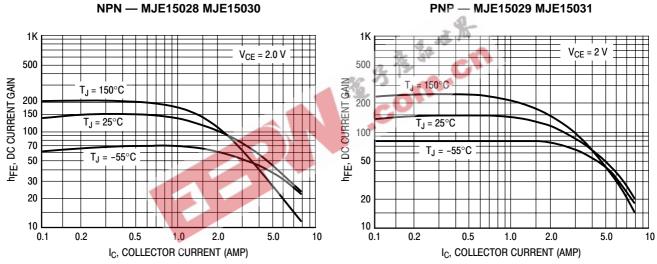


Figure 8. DC Current Gain

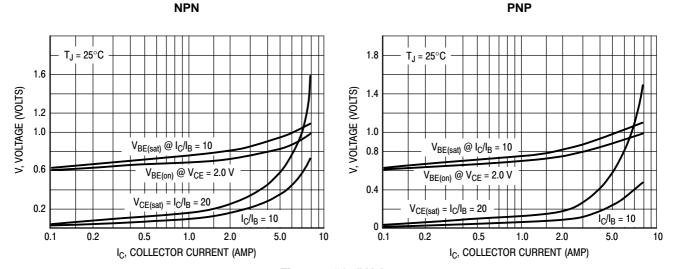
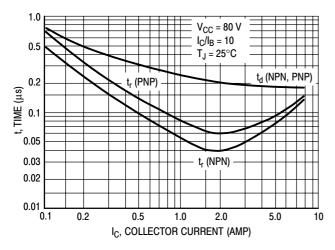


Figure 9. "On" Voltage



 $V_{CC} = 80 \text{ V}$   $I_C/I_B = 10, I_{B1} = I_{B2}$   $t_s \text{ (NPN)} \quad T_J = 25^{\circ}\text{C}$ 5.0 3.0 2.0 t, TIME (µs) ts (PNP) 1.0 t<sub>f</sub> (PNP) 0.5 0.2 t<sub>f</sub> (NPN) 0.1 L 0.1 0.2 0.3 10 5.0 I<sub>C</sub>, COLLECTOR CURRENT (AMP)

Figure 10. Turn-On Times

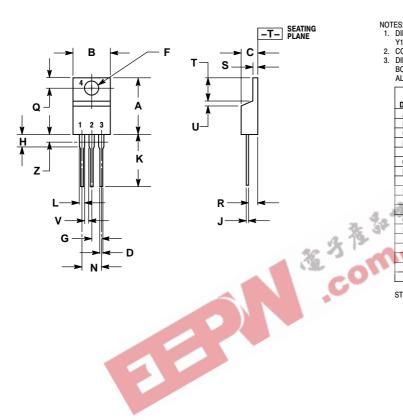
Figure 11. Turn-Off Times

## **ORDERING INFORMATION**

ORDERING INFORMATION		e A-
Device	Package	Shipping
MJE15028	TO-220	50 Units / Rail
MJE15028G	TO-220 (Pb-Free)	50 Units / Rail
MJE15029	TO-220	50 Units / Rail
MJE15029G	TO-220 (Pb-Free)	50 Units / Rail
MJE15030	TO-220	50 Units / Rail
MJE15030G	TO-220 (Pb-Free)	50 Units / Rail
MJE15031	TO-220	50 Units / Rail
MJE15031G	TO-220 (Pb-Free)	50 Units / Rail

#### PACKAGE DIMENSIONS

TO-220AB CASE 221A-09 **ISSUE AA** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI
  - Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K.	0.500	0.562	12.70	14.27
_L*	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

#### STYLE 1:

- PIN 1. BASE
  - COLLECTOR **EMITTER**
  - 3. 4. COLLECTOR

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